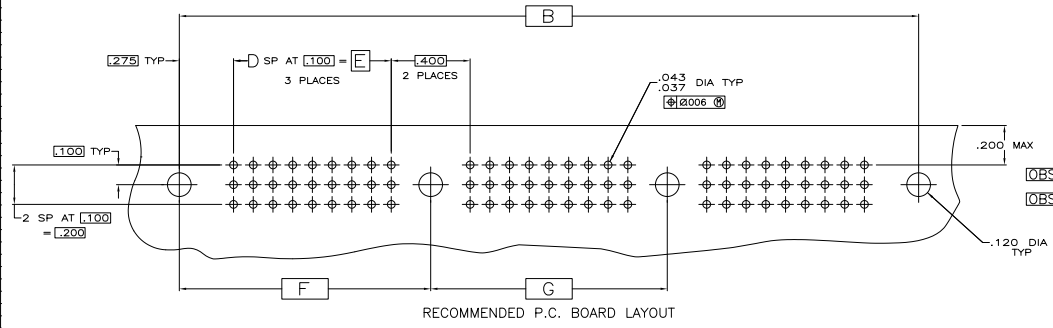
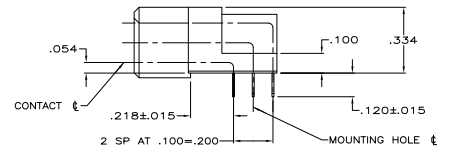
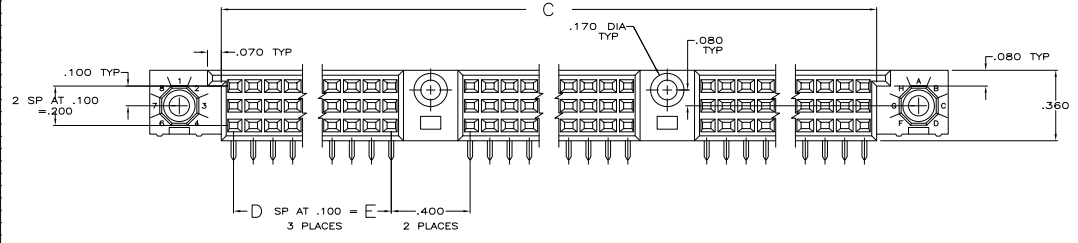
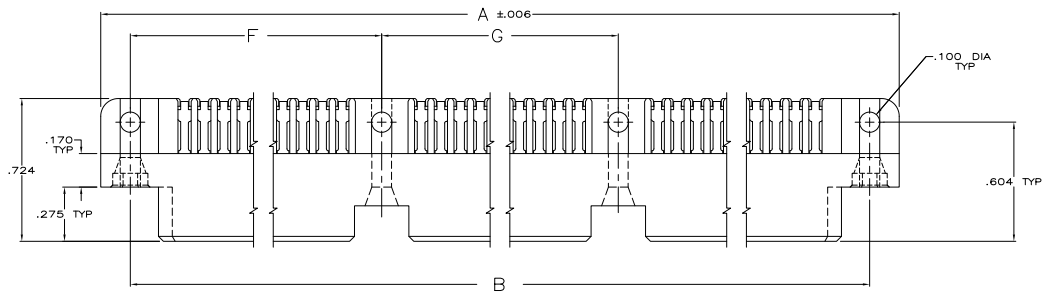


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REV	DATE	DESCRIPTION	BY	CHK	APP
AD	25				
H1		REVISED FOR ECO-08-000208			

- △ HOUSING MATERIAL: THERMOPLASTIC.
- △ CONTACT MATERIAL: BERYLLIUM COPPER.
- △ CONTACT FINISH: .000050-.000100 NICKEL UNDERPLATE ALL OVER WITH .000030 GOLD IN CONTACT AREA AND .000100-.000200 TIN-LEAD PLATED POSTS.



OBsolete	4.800	4.875	4.900	4.914	4.928	4.950	4.950	4.950	4.950	4.950	4.950	4.950	4.950	4.950	4.950	4.950	4.950	4.950
OBsolete	5.000	5.075	4.600	46	14.724	15.150	15.450	423										
OBsolete	4.600	4.675	4.200	42	13.524	13.950	14.250	387										

THIS DRAWING IS A CONTROLLED DOCUMENT.	DATE	BY	CHK	APP	REV	DATE	DESCRIPTION	BY	CHK	APP

2314K2008